

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Deyuan Xiao	04/19/2010
Xi Wang	04/19/2010
Miao Zhang	04/19/2010
Jing Chen	04/19/2010
Zhongying Xue	04/19/2010
RECEIVING PARTY DATA	
Name:	Shanghai Institute of Microsystem and Information Technology Chinese Academy of Sciences
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City:	Shanghai
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Postal Code:	200056
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12810574
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OP \$40.00 12810574

Total Attachments: 2

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ASSIGNMENT

WHEREAS, I/WE:

XIAO,DEYUAN, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

WANG,XI, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

ZHANG,MIAO, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

CHEN,JING, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

XUE,ZHONGYING, residing in
No.865, Changning Road, Changning District,
Shanghai-200056, China

have invented certain new and useful improvements in the following:

HYBRID ORIENTATION ACCUMULATION MODE GAA CMOSFET
(PCT application number:PCT/CN2010/070636)

for which a United States patent application therefor has been executed on 4/19/2010
U.S. Patent Application No.: 12810574 :

WHEREAS,

**SHANGHAI INSTITUTE OF MICROSYSTEM AND INFORMATION
TECHNOLOGY CHINESE ACADEMY OF SCIENCES**

(hereinafter referred to as the Assignee), a body having a place of business at **No.865,Changning Road,Changning District,Shanghai-200056,China** and corporate powers under the laws of **China**, desires to acquire the entire right, title and interest in said application and invention, and to any United States and foreign patents to be obtained therefor.

NOW THEREFORE, for a valuable consideration, receipt whereof is hereby acknowledged, I/we, the above named, hereby sell, assign, and transfer to Assignee, its successors and assigns, the entire right, title and interest in said application and

inventions therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said application, I/we hereby agree that Assignee may apply for foreign Letters Patent on said inventions, and I/we hereby agree to timely execute all papers necessary in connection with said United States and foreign Letters Patent applications when called upon to do so by Assignee.

I/we hereby covenant that I/we have the full and lawful right to convey the entire right, title, and interest herein assigned, and that I/we have not entered and will not enter into any agreement in conflict herewith.

I/we hereby request the Commissioner for Patents to issue any Letters Patent granted upon the inventions set forth in said application to Assignee, its successors and assigns.

Date: Apr. 19, 2010 Dequan Xiao
XIAO, DEYUAN

Date: Apr. 24, 2010 Xi Wang
WANG, XI

Date: Apr. 19, 2010 Miao Zhang
ZHANG, MIAO

Date: Apr. 19, 2010 Jing Chen
CHEN, JING

Date: Apr. 19, 2010 Zhongying Xue
XUE, ZHONGYING